4V Drive Nch MOS FET RSS085N05

Structure

Silicon N-channel MOS FET

Features

- 1) Built-in G-S Protection Diode.
- 2) Small and Surface Mount Package (SOP8).

Applications

Power switching, DC/DC converter, Inverter

Packaging dimensions

	Package	Taping	
Type	Code	TB	
	Basic ordering unit (pieces)	2500	
RSS085N08	0		

● Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit	
Drain-source voltage		V_{DSS}	45	V
Gate-source voltage		V_{GSS}	20	V
Drain current	Continuous	I _D	±8.5	Α
	Pulsed	I _{DP} *	±34	Α
Source current	Continuous	I _S	1.6	Α
(Body diode)	Pulsed	I _{SP} *	1 34	Α
Total power dissipation	P _D ∗	2 2	W	
Chanel temperature	T_ch	150	°C	
Range of Storage temperature		T_{stg}	-55 to +150	°C

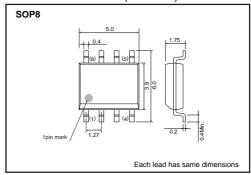
^{*1} PW≤10μs, Duty cycle≤1%

●Thermal resistance

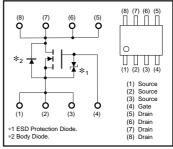
Parameter	Symbol	Limits	Unit
Chanel to ambient	R _{th(ch-a)} *	62.5	°C/W

^{*} Mounted on a ceramic board

●External dimensions (Unit : mm)



●Equivalent circuit



A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use.Use a protection circuit when the fixed voltage are exceeded.

^{*2} Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	_	10	μΑ	V _{GS} =20V, V _{DS} =0V
Drain-source breakdown voltage	$V_{(BR)\;DSS}$	45	_	_	V	I _D = 1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	_	_	1	μΑ	V _{DS} = 45V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	1.0	_	2.5	V	V _{DS} = 10V, I _D = 1mA
		_	13	18	mΩ	I _D = 8.5A, V _{GS} = 10V
Static drain-source on-state resistance	R _{DS (on)} *	_	16	23	mΩ	I _D = 8.5A, V _{GS} = 4.5V
resistance		_	18	25	mΩ	I _D = 8.5A, V _{GS} = 4V
Forward transfer admittance	Y _{fs} *	7.0	_	_	S	V _{DS} = 10V, I _D = 8.5A
Input capacitance	Ciss	-	1500	_	рF	V _{DS} = 10V
Output capacitance	Coss	_	350	_	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	170	_	рF	f=1MHz
Turn-on delay time	t _{d (on)} *	-	19	_	ns	V _{DD} ≒ 25V
Rise time	tr *	-	25	_	ns	ID= 4.0A
Turn-off delay time	td (off) *	-	71	_	ns	V _{GS} = 10V R _L =6.3Ω
Fall time	t _f *	_	24	_	ns	R _G =10Ω
Total gate charge	Qg *	-	15.3	21.4	nC	V _{DD} ≒25V V _{GS} =5V
Gate-source charge	Q _{gs} *	-	4.4	_	nC	I _D = 8.5A
Gate-drain charge	Q _{gd} *	-	6.0	_	nC	RL=2.9Ω R _G =10Ω

^{*}Pulsed

Body diode characteristics (Source-Drain) (Ta=25 $^{\circ}$ C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp*	-	_	1.2	V	I _S = 8.5A, V _{GS} =0V

^{*}Pulsed

Electrical characteristic curves

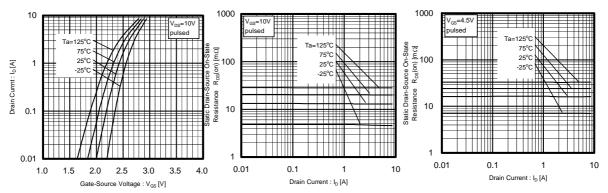


Fig.1 Typical Transfer Characteristics

Fig.2 Static Drain-Source On-State Resistance vs. Drain Current (1)

Fig.3 Static Drain-Source On-State Resistance vs. Drain Current (2)

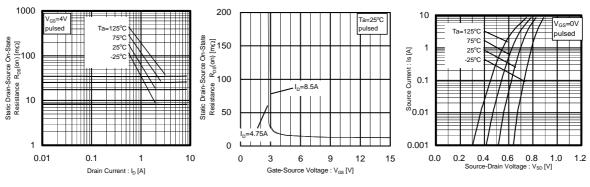


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (3)

Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

Fig.6 Source-Current vs. Source-Drain Voltage

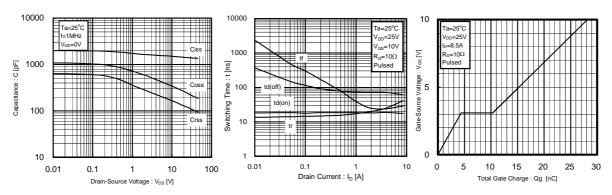


Fig.7 Typical capacitance vs. Source-Drain Voltage

Fig.8 Switching Characteristics

Fig.9 Dynamic Input Characteristics

Measurement circuits

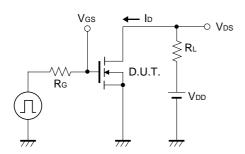


Fig.10 Switching Time Test Circuit

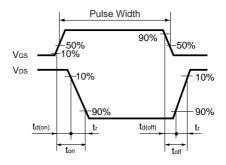


Fig.11 Switching Time Waveforms

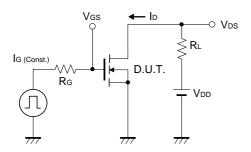


Fig.12 Gate Charge Test Circuit

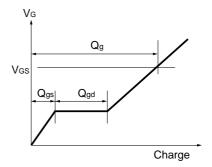


Fig.13 Gate Charge Waveform

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